



YELLOW	GMA 2885C	GMC 2885C
HER	GMA 2985C	GMC 2985C
GREEN	GMA 2485C	GMC 2485C
BICOLOR RED/GREEN	GMA 2685C	

DESCRIPTION

The drawing shows the mechanical specifications of the ST2629 package. The top view is a square with a side length of 38.4 ± 0.3 mm (1.5 ± 0.01 inches). It features a 4x4 grid of 16 pins, with a pin pitch of 7.62 mm (0.3 inches) and a total pin width of 30.48 mm (1.2 inches). The package width is 40 ± 0.2 mm. The side view shows a package height of 60.8 ± 0.3 mm (2.39 ± 0.01 inches) and a pin height of 45.72 mm (1.8 inches). The pin diameter is 0.4 mm, and the package thickness is 5.5 mm (0.22 inches). The bottom view shows the pin 1 location and the bin grade marking.

Top View Dimensions:

- Overall Width: 38.4 ± 0.3 (1.5 ± 0.01)
- Pin Pitch: 7.62 × 7 = 53.34 (2.1)
- Pin Width: 7.62 × 4 = 30.48 (1.2)
- Package Width: 40 ± 0.2 (2)
- Pin Diameter: 0.4 (16)

Side View Dimensions:

- Overall Height: 60.8 ± 0.3 (2.39 ± 0.01)
- Pin Height: 45.72 (1.8)
- Package Thickness: 5.5 (22)
- Pin Diameter: 0.4

Bottom View:

- Pin 1 Location
- Bin Grade Marking
- Pin Pitch: 2.54 × 8 = 20.32 (8)

The X in GMX denotes row anode or row cathode.

FEATURES

- 2.3" (58.4 mm) character height
- Low power requirement
- High contrast & brightness
- Wide viewing angle 130°
- 5 × 8 array with X-Y select
- Compatible with USASCII and EBCDIC codes
- X-Y stackable
- Choice of two matrix orientation anode or cathode column
- Easy mounting on PCB
- Categorized for luminous intensity
- Single color displays have the choice of 3 bright colors — yellow/orange/green
- Multicolor color displays are applicable to 3 bright colors — greens, orange (HER) and yellow (green and HER mixed)

1. ALL PINS ARE .005 (.02).
2. DIMENSIONS IN MILLIMETERS (INCH),
TOLERANCE IS ± 0.25 (.01) UNLESS
OTHERWISE NOTED.



2.3" 5 × 8 DOT MATRIX DISPLAYS

ABSOLUTE MAXIMUM RATING (T _A = 25°C unless otherwise specified)				
PARAMETER	YELLOW	HER	GREEN	UNITS
Power dissipation per dot/color	60	70	75	mW
Peak forward current per dot/color (duty cycle 1/10, 10KHz)	80	100	100	mA
Continuous I _F per dot/color	20	25	25	mA
Reverse voltage V _R per dot/color	5	5	5	V
Operating and storage temperature range	-25°C to +85°C			
Soldering time at 260°C (1/16 inch below seating plane)	3 sec			

MODEL NUMBERS						
PART NO.				DESCRIPTION	PACKAGE DIMENSION	INTERNAL CIRCUIT DIAGRAM
YELLOW	HER	GREEN	MULTI- COLOR			
GMC2885C	GMC2985C	GMC2485C		Anode column, cathode row	A	A
GMA2885C	GMA2985C	GMA2485C		Cathode column, anode row	A	B
			GMA2685C	Cathode column, anode row	B	C

ELECTRICAL/OPTICAL CHARACTERISTICS ($T_A = 25^\circ\text{C}$ Unless otherwise specified)
GMX 2485C

PARAMETER	MIN.	TYP.	MAX.	UNITS	TEST CONDITIONS
Average luminous intensity		3000		μcd	$I_F = 20\text{ mA}$
Peak emission wavelength		565		nm	$I_F = 20\text{ mA}$
Spectral line half-width		30		nm	$I_F = 20\text{ mA}$
Forward voltage, any dot		2.1	2.8	V	$I_F = 20\text{ mA}$
Reverse voltage, any dot			100	μA	$V_R = 5\text{ V}$

TYPICAL ELECTRICAL/OPTICAL CHARACTERISTIC CURVES
($T_A = 25^\circ\text{C}$ Unless otherwise specified)

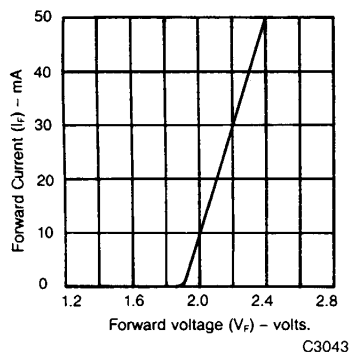


Fig. 1. Forward Current vs. Forward Voltage

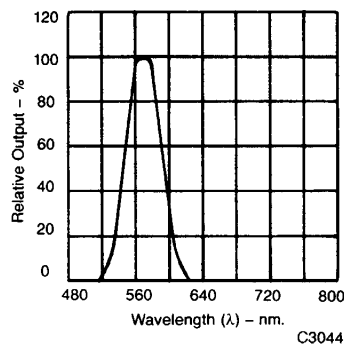


Fig. 2. Spectral Response

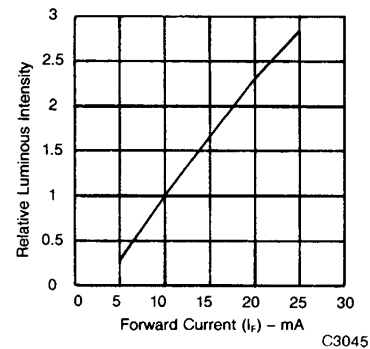


Fig. 3. Relative Luminous Intensity vs. Forward Current

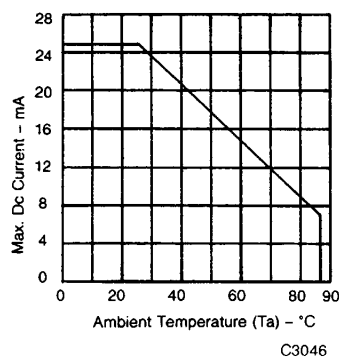


Fig. 4. Maximum Allowable DC Current Per Segment vs. Ambient Temperature

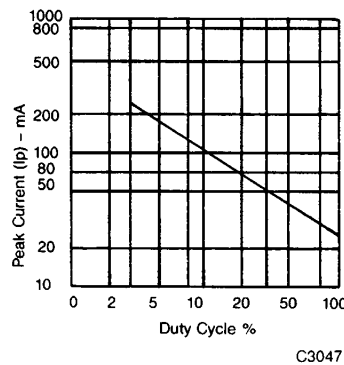


Fig. 5. Max Peak Current vs. Duty Cycle % (Refresh Rate $f = 1\text{ KHz}$)

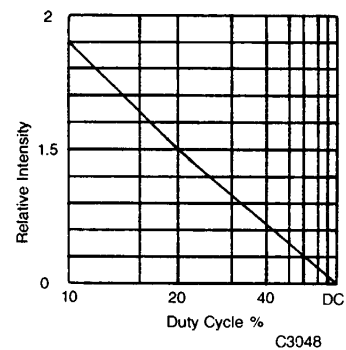


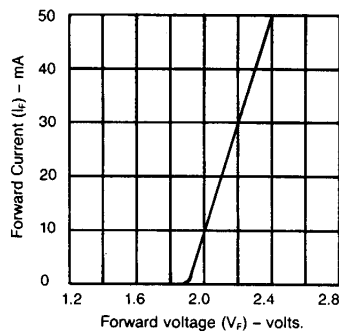
Fig. 6. Luminous Intensity vs. Duty Cycle % (Average $I = 10\text{ mA Per Seg.}$)

ELECTRICAL/OPTICAL CHARACTERISTICS ($T_A = 25^\circ\text{C}$ Unless otherwise specified)
GMX 2985C

PARAMETER	MIN.	TYP.	MAX.	UNITS	TEST CONDITIONS
Average luminous intensity		3000		μcd	$I_F = 20\text{ mA}$
Peak emission wavelength		635		nm	$I_F = 20\text{ mA}$
Spectral line half-width		30		nm	$I_F = 20\text{ mA}$
Forward voltage, any dot		2.1	2.8	V	$I_F = 20\text{ mA}$
Reverse voltage, any dot			100	μA	$V_R = 5\text{ V}$

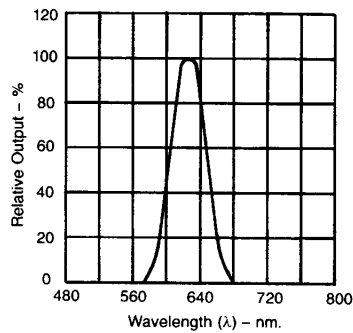
TYPICAL ELECTRICAL/OPTICAL CHARACTERISTIC CURVES

($T_A = 25^\circ\text{C}$ Unless otherwise specified)



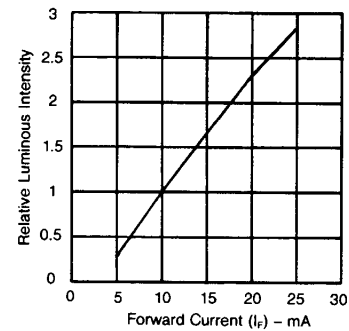
C3031

Fig. 1. Forward Current vs. Forward Voltage



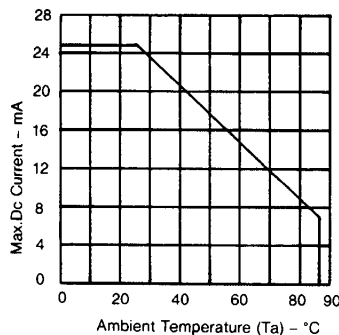
C3032

Fig. 2. Spectral Response



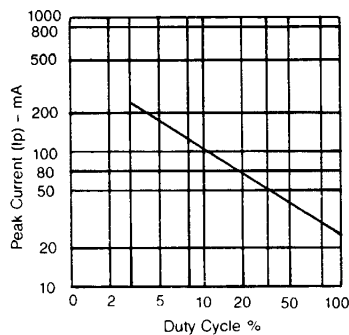
C3033

Fig. 3. Relative Luminous Intensity vs. Forward Current



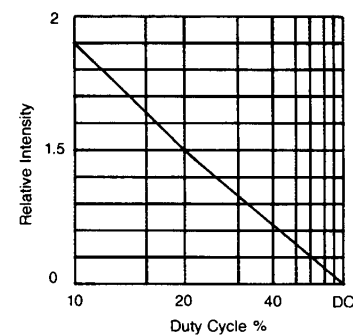
C3034

Fig. 4. Maximum Allowable DC Current Per Segment vs. Ambient Temperature



C3035

Fig. 5. Max. Peak Current vs. Duty Cycle % (Refresh Rate $f = 1\text{ KHz}$)



C3036

Fig. 6. Luminous Intensity vs. Duty Cycle %

ELECTRICAL/OPTICAL CHARACTERISTICS ($T_A = 25^\circ\text{C}$ Unless otherwise specified)
GMX 2885C

PARAMETER	MIN.	TYP.	MAX.	UNITS	TEST CONDITIONS
Average luminous intensity		3000		μcd	$I_F = 20\text{ mA}$
Peak emission wavelength		585		nm	$I_F = 20\text{ mA}$
Spectral line half-width		30		nm	$I_F = 20\text{ mA}$
Forward voltage, any dot		2.1	2.8	V	$I_F = 20\text{ mA}$
Reverse voltage, any dot			100	μA	$V_R = 5\text{ V}$

TYPICAL ELECTRICAL/OPTICAL CHARACTERISTIC CURVES
($T_A = 25^\circ\text{C}$ Unless otherwise specified)

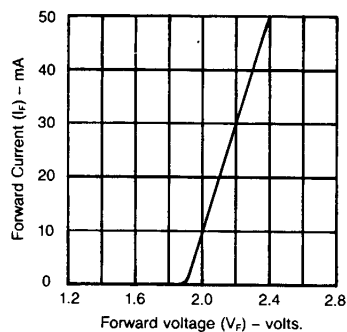


Fig. 1. Forward Current vs. Forward Voltage

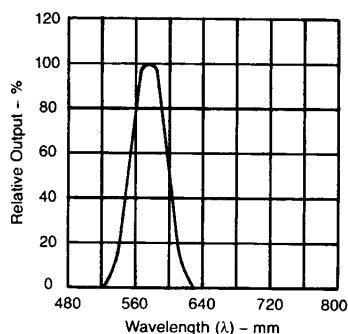


Fig. 2. Spectral Response

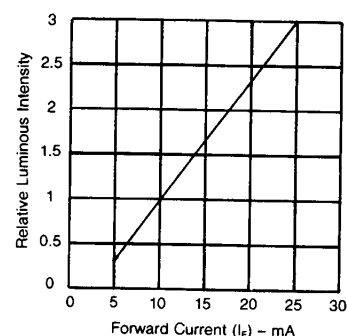


Fig. 3. Relative Luminous Intensity vs. Forward Current

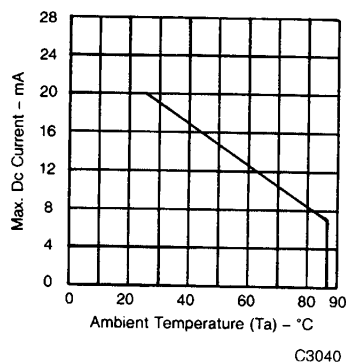


Fig. 4. Maximum Allowable DC Current Per Segment vs. Ambient Temperature

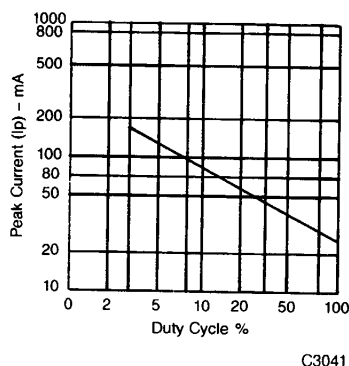


Fig. 5. Max Peak Current vs. Duty Cycle % (Refresh Rate $f = 1\text{ KHz}$)

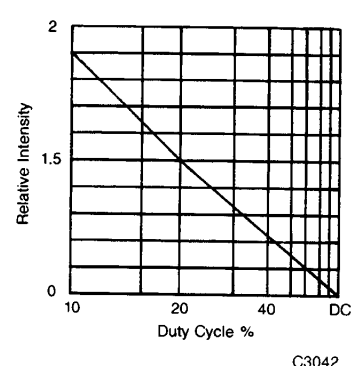


Fig. 6. Luminous Intensity vs. Duty Cycle % (Average $I = 10\text{ mA Per Seg.}$)

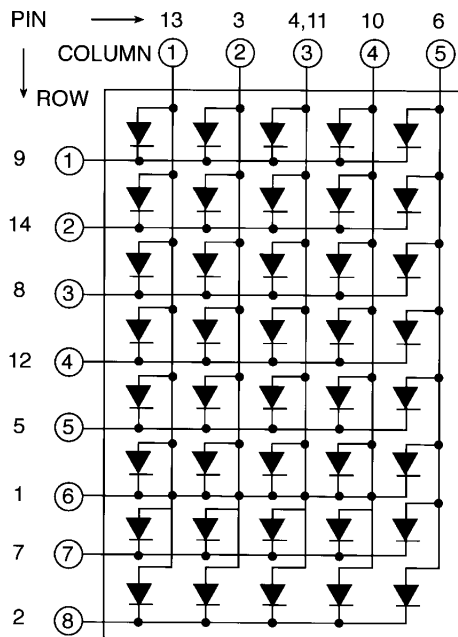


**2.3" 5 × 8
DOT MATRIX DISPLAYS**

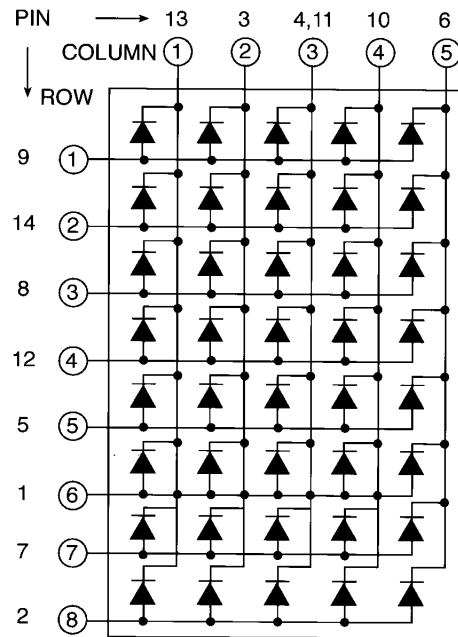
PIN CONNECTION			
PIN NO.	GMC2X85C	GMA2X85C	GMC2685C
1	Cathode row 6	Anode row 6	Cathode column 1 green
2	Cathode row 8	Anode row 8	Cathode column 2 green
3	Anode column 2	Cathode column 2	Cathode column 2 HER
4	Anode column 3	Cathode column 3	Cathode column 3 HER
5	Cathode row 5	Anode row 5	Anode row 6
6	Anode column 5	Cathode column 5	Anode row 7
7	Cathode row 7	Anode row 7	Cathode column 4 HER
8	Cathode row 3	Anode row 3	Anode row 5
9	Cathode row 1	Anode row 1	Anode row 8
10	Anode column 4	Cathode column 4	Cathode column 5 green
11	Anode column 3	Cathode column 3	Cathode column 5 HER
12	Cathode row 4	Anode row 4	Cathode column 4 green
13	Anode column 1	Cathode column 1	Anode column 3 green
14	Cathode row 2	Anode row 2	Anode row 4
15			Anode row 2
15			Anode row 1
15			Anode row 3
15			Cathode column 1 HER

INTERNAL CIRCUIT DIAGRAM

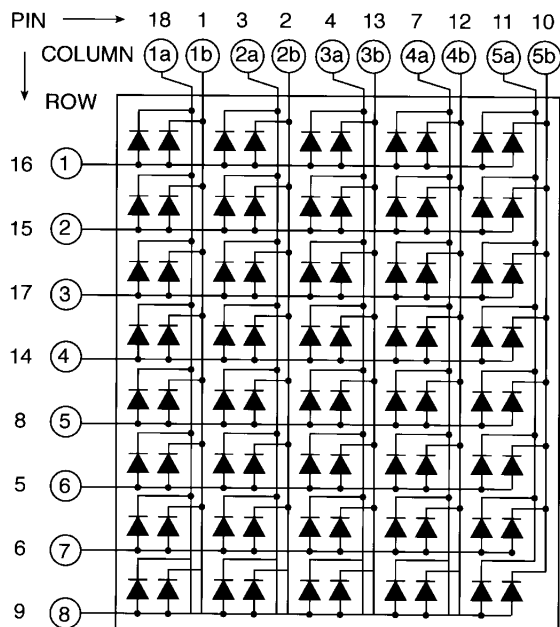
A. GMC2X85C



B. GMA2X85C



C. GMA2685C





2.3" 5 X 8 DOT MATRIX DISPLAYS

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